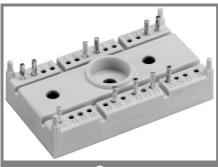
SK 40 GARL 067 E



SEMITOP® 3

IGBT Module

SK 40 GARL 067 E

Target Data

Features

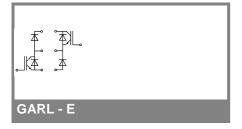
- Compact design
- · One screw mounting
- Heat transfer and isolation through direct copper bonding aluminium oxide ceramic (DBC)
- Hyper fast NPT IGBT
- N-channel homogeneous silicon structure (NPT-Non punch-through IGBT)
- Positive Vcesat temperature coefficient (Easy paralleling)
- Low threshold voltage
- Low tail current with low temperature dependence

Typical Applications

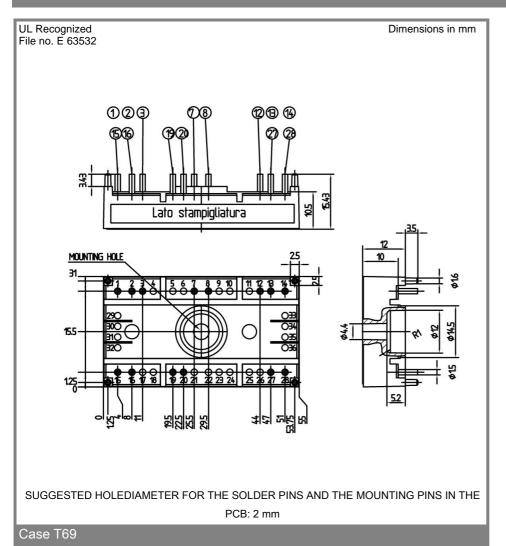
- Switching (not for linear use)
- High Frequencies Applications
- Welding Generator
- Switched mode power supplies
- UPS

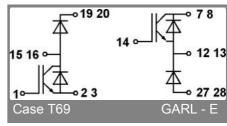
Absolute	Maximum Ratings	T _s = 25 °C, unless otherwise specified					
Symbol	Conditions	Values	Units				
IGBT		•	•				
V_{CES}		600	V				
V_{GES}		± 20	V				
I _C	T _s = 25 (80) °C;	62 (41)	Α				
I _{CM}	$t_p < 1 \text{ ms}; T_s = 25 (80) ^{\circ}\text{C};$	124 (82)	Α				
T_{j}	·	- 40 + 150	°C				
Freewheeling Diode							
I _F	T _s = 25 (80) °C;	62 (38)	Α				
$I_{FM} = -I_{CM}$	$t_p < 1 \text{ ms}; T_s = 25 (80) ^{\circ}\text{C};$	124 (76)	Α				
T _j		- 40 + 150	°C				
T _{stg}		- 40 + 125	°C				
T _{sol}	Terminals, 10 s	260	°C				
V _{isol}	AC 50 Hz, r.m.s. 1 min. / 1 s	2500 / 3000	V				

Characteristics		T _s = 25 °C	T _s = 25 °C, unless otherwise specified			
Symbol	Conditions	min.	typ.	max.	Units	
IGBT					•	
$V_{\text{CE(sat)}} \\ V_{\text{GE(th)}} \\ C_{\text{ies}} \\ R_{\text{th(j-s)}}$	I_{C} = 90 A, T_{j} = 25 (125) °C V_{CE} = V_{GE} ; I_{C} = 0,0021 A V_{CE} = 15 V; V_{GE} = 0 V; 1 MHz per IGBT per module	3	2,8 (3,5) 4 4,5	5 0,6	V V nF K/W K/W	
$t_{d(on)}$ t_r $t_{d(off)}$ t_f $E_{on} + E_{off}$	under following conditions: $V_{CC} = 400 \text{ V}, V_{GE} = \pm 15 \text{ V}$ $I_{C} = 90 \text{ A}, T_{j} = 125 \text{ °C}$ $R_{Gon} = R_{Goff} = 11 \Omega$ Inductive load		20 10 270 28 5,1		ns ns ns ns	
	eling Diode				I	
$V_F = V_{EC}$ $V_{(TO)}$ r_T $R_{th(j-s)}$	I _F = 90 A; T _j = 25 (150) °C T _j = (150) °C T _j = (150) °C		(1,25) (1) (5,5)	2 1,2	V V mΩ K/W	
I _{RRM} Q _{rr} E _{off}	under following conditions: $I_F = 90 \text{ A}; V_R = 400 \text{ V}$ $dI_F/dt = -100 \text{ A/}\mu\text{s}$ $V_{GE} = 0 \text{ V}; T_j = 125 \text{ °C}$				Α μC mJ	
Mechanic	cal data				·	
M1	mounting torque	2,3		2,5	Nm	
w			29		g	
Case	SEMITOP® 3		T 69			



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This is an electrostatic discharge sensitive device (ESDS), international standard IEC 60747-1, Chapter IX.

This technical information specifies semiconductor devices but promises no characteristics. No warranty or guarantee expressed or implied is made regarding delivery, performance or suitability.